PATENT NUMBER

U.S. UTILITY Patent Application

M.P.E.

SCANNED _____ Q.A. _____

PATENT DATE

APPLICATION NO.	CONT/PRIOR	CLASS	SUBCLASS	ART.UNIT	EXAMINER
09/839508		451	008	3723	

APPLICANTS

In Jeong

TITLE

Apparatus and method for sequentially polishing and
loading/unloading semiconductor wafers

PTO-2040
12/99

ISSUING CLASSIFICATION

ORIGINAL			CROSS REFERENCE(S)					
CLASS	SUBCLASS	CLASS	SUBCLASS (ONE SUBCLASS PER BLOCK)					
INTERNATIONAL CLASSIFICATION								
				☐ Continued on Issue Slip Inside File Jacket				

TERMINAL ☐ DISCLAIMER	DRAWINGS			CLAIMS ALLOWED	
	Sheets Drwg.	Figs. Drwg.	Print Fig.	Total Claims	Print Claim for O.G.
☐ The term of this patent subsequent to _____ (date) has been disclaimed.	(Assistant Examiner) (Date)			NOTICE OF ALLOWANCE MAILED	
☐ The term of this patent shall not extend beyond the expiration date of U.S Patent. No. _____				ISSUE FEE	
_____ _____				Amount Due	Date Paid
	(Primary Examiner) (Date)				
☐ The terminal ____ months of this patent have been disclaimed.	(Legal Instruments Examiner) (Date)			ISSUE BATCH NUMBER	

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